

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SONY CORPORATION	07/29/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
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<b>City:</b>	KANAGAWA
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	243-0014
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29553148
<b>Application Number:</b>	29558190
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	880201-3088-US00
<b>NAME OF SUBMITTER:</b>	BRIAN K. DUTTON/NNC
<b>SIGNATURE:</b>	/Brian K. Dutton/
<b>DATE SIGNED:</b>	10/06/2016
<b>Total Attachments: 2</b>	
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source=19666235_880201-3088-US00_executed_Assignment_-_Sony_Semiconductor_Solutions_Corporation#page2.tif	

## ASSIGNMENT

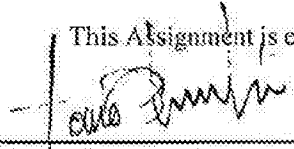
For good and valuable consideration, the receipt of which is hereby acknowledged, Sony Corporation ("ASSIGNOR"), a company having offices in Tokyo, Japan, has sold, assigned, and transferred and does hereby sell, assign, and transfer to Sony Semiconductor Solutions Corporation ("ASSIGNEE"), a company having offices at 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, 243-0014 Japan, for itself and its successors, transferees, and assignees, the following:

The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the patent applications as set forth in the enclosed APPENDIX ("APPLICATIONS"), and, the entire worldwide right, title, and interest in and to: (a) each of the APPLICATIONS; (b) all applications claiming priority from each of the APPLICATIONS; (c) all utility, divisional, continuation, substitute, renewal, and reissue applications for each of the APPLICATIONS that have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b) and (c) above; and (d) all right of priority in each of the APPLICATIONS, together with all rights to recover damages for infringement of provisional rights.

ASSIGNOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

ASSIGNOR represents that ASSIGNOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the ASSIGNOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

This Assignment is executed on the date(s) indicated below.

  
\_\_\_\_\_  
Tomonori Okuwaki  
Deputy Senior General Manager,  
Intellectual Property Division  
Authorized Officer, Sony Corporation  
(ASSIGNOR)

Date: 07/29/2016

# APPENDIX

Attorney Reference #	US APPL. SERIAL #	PCT APPL. #	FILING DATE	Title
880201-3080-US00	29/553,148		01/28/2016	DISPLAY MODULE
880201-3088-US00	29/558,190		03/15/2016	HOUSING FOR ELECTRIC DEVICE

Assignment:  
Sony Corporation to Sony Semiconductor Solutions Corporation